



S O S G R O U P

Fogale Nanotech DEEPROBE 300-M
SN DPB-7DA-001
Vintage +/- 2014

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located Nijmegen the Netherlands

Technology

Low Coherence IR interferometry for step high measurement

Applications

High A/R TSV depth measurement for 200 and 300mm wafer (Via first & Middle)

Benefits

Non destructive Technology

Fast and easy to use

CCD camera for spot positioning and pattern recognition

Adjustable Metrology spot size

TSV diameter > 2um A:R up to 30

Calibration and maintenance free



SENTECH Senduro 300

SN 33/011

Vintage 2008

located Nijmegen the Netherlands



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Supplier of first class second source materials

